Master of Science Program Planning Sheet

Electrical and Computer Engineering

Department of Electrical and Computer Engineering



MATRICULATION YEAR FALL 2019

| Student's Name (In Print): | BU ID |
|--|---|
| Advisor Name (in Print): | |
| Students are required to earn a total of 32 credits (8 co with grades of C or better in order to graduate. Studen credits used toward the degree. If cumulative GPA dropprobation. | ts must achieve a degree GPA >=3.0 for the 32 |
| PROGRAM REQUIREMENTS | |
| 1. SOFTWARE REQUIREMENT (4 credits) EC602: Design by Software in ECE* See no | te below |
| 2. PRACTICUM REQUIREMENT (4 credits) - EC601: Product Design in ECE* See note be Students who place out of EC601 must then sel EC953: MS Project EC954: MS Thesis | pelow |
| 3. ECE GRADUATE ELECTIVES (16 credits) - graduate courses at the 500-level or above | · · · · · · · · · · · · · · · · · · · |
| electives (not counted for their ECE elective Engineering graduate-level courses <i>except</i> c | ts may take 8 credits (2 courses) of general graduate s). General graduate electives include College of ourses utilized to meet other requirements. Graduate ed by the department MS committee; those listed on e-approved. |
| Student SignatureA Departmental Signature | |

^{*}Note: In order to waive or be exempt from this requirement, students must pass a placement exam typically given at the beginning of the academic year.

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Electives

(See the College of Engineering Bulletin for course descriptions)

The following subdivisions are provided-for informational purposes only-to guide you in choosing electives according to your interests.

Bio-ECE and Digital Health

EC505 EC516 EC520 EC555 EC571 EC580 EC582 EC716 EC717 EC720 EC772 EC782 EC765

Computational and Cyberphysical Systems

EC501 EC504 EC524 EC 535 EC541 EC544 EC605 EC701 EC724 ME740 ME570

Computer Communications and Networks

EC505 EC508 EC515 EC521 EC524 EC534 EC541 EC544 EC561 EC715 EC724 EC725 EC727 EC733 EC741 EC744 EC749

Cybersecurity

EC503 EC504 EC521 EC535 EC541 EC544 CS548 CS552 CS558 CS568

Data Science and Intelligent Systems

EK500 EC503 EC504 EC505 EC528 EC517 EC524 EC541 EC544 EC719 EC724 EC733 CS542

Hardware

EC513 EC527 EC535 EC551 EC561 EC571 EC580 EC582 EC605 EC713 EC749 EC752 EC753 EC757 EC772 EC782

Imaging and Optical Science

EC520 EC555 EC562 EC568 EC577 EC762 EC763 EC777

Mobile and Cloud Computing

EC504 EC521 EC528 EC535 EC541 EC544 CS538 CS548 CS558 CS568 EC605

Photonics, Electronics, and Nanotechnology

EC555 EC562 EC563 EC566 EC568 EC569 EC570 EC573 EC579 EC591 EC707 EC731 EC760 EC762 EC763 EC764 EC765 EC770 EC773 EC777

Sensing and Information

EC503 EC504 EC505 EC508 EC515 EC516 EC517 EC520 EC521 EC702 EC715 EC716 EC717, EC719, EC720

Signal Processing and Communications

EC503 EC505 EC508 EC515 EC516 EC517 EC519 EC520 EC541 EC702 EC715 EC716 EC717 EC719 EC720

Solid-State Circuits, Devices, and Materials

EC571 EC574 EC575 EC577 EC578 EC579 EC580 EC582 EC770 EC771 EC772 EC774 EC775 EC777 EC782

Software

EC504 EC511 EC512 EC521 EC527 EC528 EC535 EC544 EC605 EC712 EC730

Systems and Control

EC501 EC505 EC517 EC524 EC701 EC702 EC710 EC724 EC733 EC724 EC732 EC733 CS506 CS562 CS542 CS565 CS660 MA751 BE562 BI572 BE575 ME570 ME740